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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.	
10/665,322	09/20/2003	William J. Murphy	BUR9-1999-0044US2	6242	
759	09/22/2004		EXAM	INER	
Robert A. Walsh 1000 River St. 972E			WARREN, M	WARREN, MATTHEW E	
Essex Junction,			ART UNIT	PAPER NUMBER	
			2815		

DATE MAILED: 09/22/2004

Please find below and/or attached an Office communication concerning this application or proceeding.

<del></del>		<del>, , , , , , , , , , , , , , , , , , , </del>			
	Application No.	Applicant(s)			
Office Action Summers	10/665,322	MURPHY, WILLIAM J.			
Office Action Summary	Examiner	Art Unit			
	Matthew E Warren	2815			
The MAILING DATE of this communication appearing for Reply	pears on the cover sheet with the c	correspondence address			
A SHORTENED STATUTORY PERIOD FOR REPL THE MAILING DATE OF THIS COMMUNICATION.  - Extensions of time may be available under the provisions of 37 CFR 1.' after SIX (6) MONTHS from the mailing date of this communication.  - If the period for reply specified above is less than thirty (30) days, a rep  - If NO period for reply is specified above, the maximum statutory period  - Failure to reply within the set or extended period for reply will, by statute Any reply received by the Office later than three months after the mailin earned patent term adjustment. See 37 CFR 1.704(b).	136(a). In no event, however, may a reply be tin ly within the statutory minimum of thirty (30) day will apply and will expire SIX (6) MONTHS from e, cause the application to become ABANDONE	nely filed s will be considered timely. the mailing date of this communication. D (35 U.S.C. § 133).			
Status					
1) Responsive to communication(s) filed on 10 J	<u>uly 2004</u> .				
2a)⊠ This action is <b>FINAL</b> . 2b)☐ This	s action is non-final.				
Since this application is in condition for allowance except for formal matters, prosecution as to the merits is closed in accordance with the practice under <i>Ex parte Quayle</i> , 1935 C.D. 11, 453 O.G. 213.					
Disposition of Claims					
4) Claim(s) <u>18-32</u> is/are pending in the application 4a) Of the above claim(s) is/are withdrates 5) Claim(s) is/are allowed.  6) Claim(s) <u>18-25,27-29,31 and 32</u> is/are rejecte	wn from consideration.				
7)⊠ Claim(s) <u>26 and 30</u> is/are objected to. 8)☐ Claim(s) are subject to restriction and/o					
Application Papers					
9) The specification is objected to by the Examine	er				
D) ☐ The drawing(s) filed on is/are: a) ☐ accepted or b) ☐ objected to by the Examiner.					
Applicant may not request that any objection to the					
Replacement drawing sheet(s) including the correct 11) The oath or declaration is objected to by the E					
Priority under 35 U.S.C. § 119					
12) Acknowledgment is made of a claim for foreign a) All b) Some * c) None of:  1. Certified copies of the priority document 2. Certified copies of the priority document 3. Copies of the certified copies of the priority document application from the International Bureat * See the attached detailed Office action for a list	its have been received. Its have been received in Applicat Drity documents have been receive Bu (PCT Rule 17.2(a)).	ion No ed in this National Stage			
Attachment(s)					
<ol> <li>Notice of References Cited (PTO-892)</li> <li>Notice of Draftsperson's Patent Drawing Review (PTO-948)</li> <li>Information Disclosure Statement(s) (PTO-1449 or PTO/SB/08 Paper No(s)/Mail Date</li> </ol>	4) Interview Summary Paper No(s)/Mail D 5) Notice of Informal F 6) Other:	r (PTO-413) ate Patent Application (PTO-152)			

### **DETAILED ACTION**

This Office Action is in response to the Amendment filed on July 10, 2004.

## Claim Rejections - 35 USC § 102

The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless -

(e) the invention was described in (1) an application for patent, published under section 122(b), by another filed in the United States before the invention by the applicant for patent or (2) a patent granted on an application for patent by another filed in the United States before the invention by the applicant for patent, except that an international application filed under the treaty defined in section 351(a) shall have the effects for purposes of this subsection of an application filed in the United States only if the international application designated the United States and was published under Article 21(2) of such treaty in the English language.

Claims 18-25, 27-29, 31, and 32 are rejected under 35 U.S.C. 102(e) as being anticipated by Li (US 6,136,690).

In re claim 18, Li shows (fig. 1) a refractory metal liner (110, 120, 130a) comprising a barrier (TiN layer 120) comprising a passivating agent (nitrogen). The barrier impedes a subsequent reaction of a top half of the refractory metal liner with an adjacent conductive layer (103) (col. 5, lines 35-50). The barrier is limited to the central portion (layer 120) of the refractory metal.

In re claims 19-23, Li discloses (col. 5, lines 35-50) impurities from an adjacent conductive layer (130) are limited to the top half of the refractory metal liner. The barrier impedes impurities from diffusing from the adjacent conductive layer (103) through the refractory metal since TiN nitride naturally impedes silicon and fluorine. (Chen et al. [US 5,874,356] in col. 1, lines 47-57 states that TiN has barrier properties that protect

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against the diffusion of silicon from the substrate and fluorine from subsequent tungsten deposition). A second conductive layer (130) is positioned over the refractory metal (110, 120, 130a). The barrier impedes impurities from diffusing from the second conductive layer and the impurities comprise fluorine (col. 5, lines 47-50).

In re claim 24, Li discloses that the refractory metal liner comprises titanium and the passivating agent comprises nitrogen (col. 5, lines 47-50 and col. 6, lines 23-31).

In re claim 25, Li shows (fig. 1) an electrical connection in an integrated circuit chip comprising a first conductive layer (103), and a liner (110, 120, 130a) on the first conductive layer. The liner includes a barrier (120) that impedes impurities from diffusing from the first conductive layer through the liner. A second conductive layer (130) is formed over the liner and the barrier also impedes second impurities from diffusing from the second conductive layer through the liner (col. 5, lines 35-50). The barrier is limited to the central portion (layer 120) of the refractory metal line wherein first impurities are positioned within the portion of the liner adjacent the first conductive layer and second impurities are positioned within the portion of the liner adjacent the second conductive layer.

In re claim 27, Li discloses that the refractory metal liner comprises titanium and the passivating agent comprises nitrogen (col. 5, lines 47-50 and col. 6, lines 23-31). The second conductive layer comprises tungsten.

In re claim 28, Li discloses that the impurities comprise fluorine (col. 5, lines 47-50).

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In re claim 29, Li shows (fig. 1) an integrated circuit chip comprising a first conductive layer (103), and a liner (110, 120, 130a) on the first conductive layer. The liner includes a barrier (nitrogen) that impedes impurities from diffusing from the first conductive layer through the liner. A second conductive layer (130) is formed over the liner and also impedes impurities from diffusing from the second conductive layer through the liner (col. 5, lines 35-50). The barrier is limited to the central portion (layer 120) of the refractory metal line wherein first impurities are positioned within the portion of the liner adjacent the first conductive layer and second impurities are positioned within the portion of the liner adjacent the second conductive layer.

In re claim 31, Li discloses that the refractory metal liner comprises titanium and the passivating agent comprises nitrogen (col. 5, lines 47-50 and col. 6, lines 23-31). The second conductive layer comprises tungsten.

In re claim 32, Li discloses that the impurities comprise fluorine (col. 5, lines 47-50).

#### Allowable Subject Matter

Claims 26 and 30 are objected to as being dependent upon a rejected base claim, but would be allowable if rewritten in independent form including all of the limitations of the base claim and any intervening claims.

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## Response to Arguments

Applicant's arguments with respect to claims 18-32 have been considered but are most in view of the new ground(s) of rejection.

#### Conclusion

Applicant's amendment necessitated the new ground(s) of rejection presented in this Office action. Accordingly, **THIS ACTION IS MADE FINAL**. See MPEP § 706.07(a). Applicant is reminded of the extension of time policy as set forth in 37 CFR 1.136(a).

A shortened statutory period for reply to this final action is set to expire THREE MONTHS from the mailing date of this action. In the event a first reply is filed within TWO MONTHS of the mailing date of this final action and the advisory action is not mailed until after the end of the THREE-MONTH shortened statutory period, then the shortened statutory period will expire on the date the advisory action is mailed, and any extension fee pursuant to 37 CFR 1.136(a) will be calculated from the mailing date of the advisory action. In no event, however, will the statutory period for reply expire later than SIX MONTHS from the date of this final action.

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Matthew E Warren whose telephone number is (571) 272-1737. The examiner can normally be reached on Mon-Thur and alternating Fri 9:00-5:00pm.

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If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Tom Thomas can be reached on (571) 272-1664. The fax phone number for the organization where this application or proceeding is assigned is 703-872-9306.

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free).

MEW

Mew September 17, 2004 TOM THOMAS

SUPERVISORY PATENT EXAMINER
TECHNOLOGY CENTER 2800

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